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## Product Change Notification - B2M2000008 - JAON-08DHBR103 (Printer Friendly)

**Date:** 07 Oct 2016  
**Product Category:** Analog (Thermal, Power Management & Safety)  
**Notification subject:** CCB 1737.06 Final Notice: Release to production of listed Micrel MOSFET Driver product type manufactured with the B2M2 process technology to Microchip Fab.  
**Notification text:** **PCN Status:** Final Notification

Note: This final PCN only pertains to the products listed in this PCN. Additional final PCNs may be issued for this combination of product type and process technology.

**Microchip Parts Affected:**

Please open the attachments found in the attachments field below labeled as PCN\_#\_Affected\_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:**

Release to production of listed Micrel MOSFET Driver product type manufactured with the B2M2 process technology to Microchip Fab.

NOTE: Please review the FAQ linked [here](#) for additional information about this change.

**Pre Change:**

Fabricated at Micrel fabrication site (San Jose, CA, USA) using 6 inch wafers.

**Post Change:**

Fabricated at Microchip fabrication site using 8 inch wafers.

**Pre and Post Change Summary:**

|                 | Pre Change              | Post Change                |
|-----------------|-------------------------|----------------------------|
| <b>Fab Site</b> | Micrel fabrication site | Microchip fabrication site |

|                   |                     |               |
|-------------------|---------------------|---------------|
|                   | (San Jose, CA, USA) |               |
| <b>Wafer Size</b> | 6 inch wafers       | 8 inch wafers |

**Impacts to Data Sheet:**

None

**Reason for Change:**

To improve productivity with the closure of the Micrel fab as part of the integration of Micrel and Microchip.

**Change Implementation Status:**

In Progress

**Estimated First Ship Date:**

As identified for each CPN listed in the attached parts list.

**Summary Time Table of notable events to date:**

|   | September 2015 |    |    |    |    | -> | April 2016 |    |    |    | -> | October 2016 |    |    |    | November 2016 |    |    |    |                                       |
|---|----------------|----|----|----|----|----|------------|----|----|----|----|--------------|----|----|----|---------------|----|----|----|---------------------------------------|
|   | 36             | 37 | 38 | 39 | 40 |    | 14         | 15 | 16 | 17 |    | 40           | 41 | 42 | 43 | 44            | 45 | 46 | 47 |                                       |
| Initial PCN Issue Date<br><br>CYER-31JLEX869          | X              |    |    |    |    |    |            |    |    |    |    |              |    |    |    |               |    |    |    |                                       |
| Qual Report Available<br><br>JAON-08DHBR103           |                |    |    |    |    |    | X          |    |    |    |    |              |    |    |    |               |    |    |    |                                       |
| Final PCN Issue Date<br><br>JAON-08DHBR103-B2M2000008 |                |    |    |    |    |    |            |    |    |    |    | X            |    |    |    |               |    |    |    |                                       |
| Estimated First Ship Date                             |                |    |    |    |    |    |            |    |    |    |    |              |    |    |    |               |    |    |    | As listed in the attached parts list. |

**Markings to Distinguish Revised from Unrevised Devices:**

Traceability code and shipping label see [FAQ](#).

**Revision History:**

**September 1, 2015:** Issued initial notification as PCN number **CYER-31JLEX869**.

**April 12, 2016:** Issued intermediate notification as PCN number **JAON-08DHBR103**. Attached the Qualification Report. Revised the estimated first ship date (EFSD) to inform that the EFSD will be revealed in the final PCN.

**October 7, 2016:** Issued final notification as PCN number **JAON-08DHBR103-B2M2000008** for listed Micrel's MOSFET Driver products manufactured with the B2M2 process technology. Provided estimated first ship date (EFSD) for each CPN listed in the attached parts list.

The change described in this PCN does not alter Micrel's or Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):** [PCN\\_JAON-08DHBR103\\_Qual Report.pdf](#)  
[PCN\\_JAON-08DHBR103-B2M2000008\\_Affected\\_CPN.pdf](#)  
[PCN\\_JAON-08DHBR103-B2M2000008\\_Affected\\_CPN.xls](#)

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